

Surface Mount Rectifiers

1.2 A, 600 V – 1000 V

S1JFP - S1MFP

Features

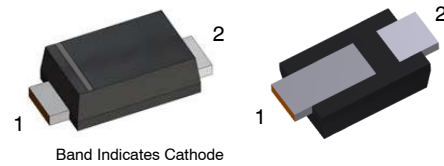
- Low Power Loss, High Efficiency
- Larger Cathode Pad for Improved Power Dissipation
- Ultra Thin Profile – Package Height < 1.0 mm
- High Surge Capability
- Low Forward Voltage: 1.3 V Maximum
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- Industrial Device Qualified per AEC-Q101 Standards
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

MAXIMUM RATINGS

T_A = 25 °C unless otherwise noted

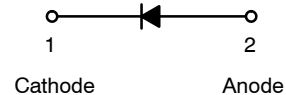
Symbol	Rating	Value			Unit
		S1JFP	S1KFP	S1MFP	
V _{RRM}	Repetitive Peak Reverse Voltage	600	800	1000	V
V _{RMS}	RMS Reverse Voltage	420	560	700	V
V _R	DC Blocking Voltage	600	800	1000	V
I _{F(AV)}	Average Forward Rectified Current	1.2			A
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	50			A
T _J	Operating Junction Temperature Range	–55 to +150			°C
T _{STG}	Storage Temperature Range	–55 to +150			°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

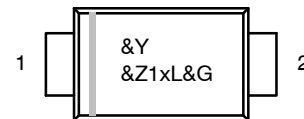


Band Indicates Cathode

SOD-123EP
CASE 425AC



MARKING DIAGRAM



&Y = Binary Calendar Year Coding
 &Z = Assembly Plant Code
 1xL = Specific Device Code
 x = J, K, M
 &G = Single Digit Week Code

ORDERING INFORMATION

Device	Package	Shipping [†]
S1JFP	SOD-123EP	3000 / Tape & Reel
S1KFP	SOD-123EP	3000 / Tape & Reel
SMFP	SOD-123EP	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, [BRD8011/D](#).

S1JFP – S1MFP

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted (Note 1))

Symbol	Characteristic	Value	Unit
Ψ_{JL}	Typical Thermal Characteristics, Junction-to-Lead (Note 2)	12	$^{\circ}\text{C/W}$
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient	140	$^{\circ}\text{C/W}$

1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
2. Thermocouple soldered at cathode lead.

ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	Instantaneous Forward Voltage (Note 3)	$I_F = 1.2\text{ A}$	–	–	1.3	V
I_R	Reverse Current at Rated V_R	$T_J = 25\text{ }^{\circ}\text{C}$	–	–	5	μA
		$T_J = 125\text{ }^{\circ}\text{C}$	–	–	150	
C_J	Junction Capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$	–	18	–	pF
T_{rr}	Reverse Recovery Time	$I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$	–	1.5	–	μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse test with $PW = 300\text{ }\mu\text{s}$, 1% duty cycle

S1JFP – S1MFP

TYPICAL PERFORMANCE CHARACTERISTICS

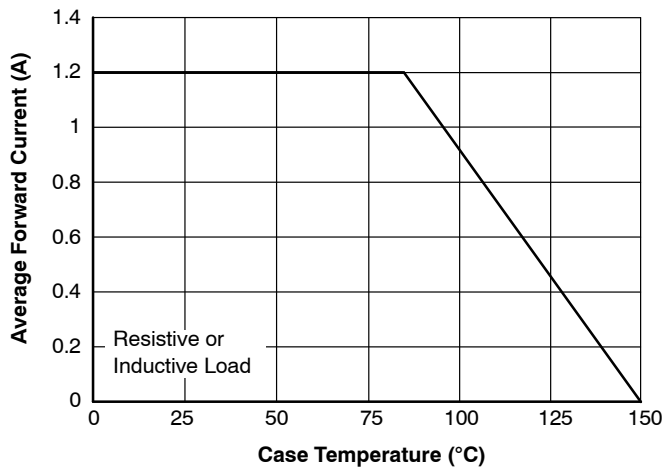


Figure 1. Maximum Forward Current Derating Curve

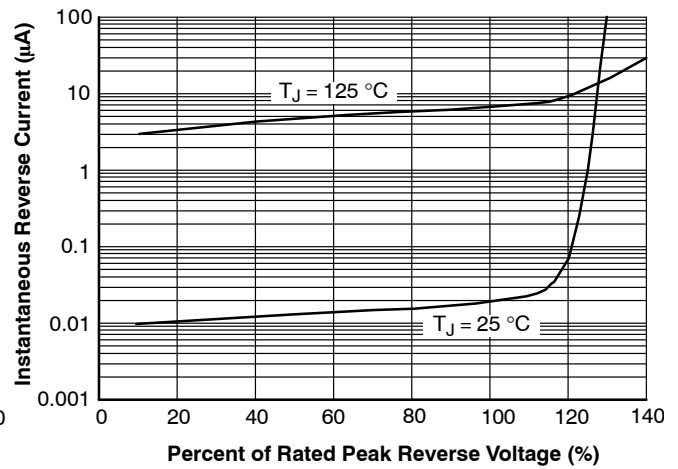


Figure 2. Typical Reverse Characteristics

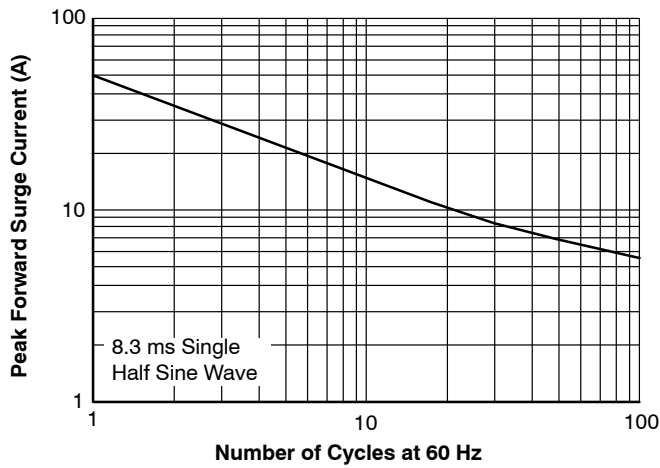


Figure 3. Maximum Non-Repetitive Forward Surge Current

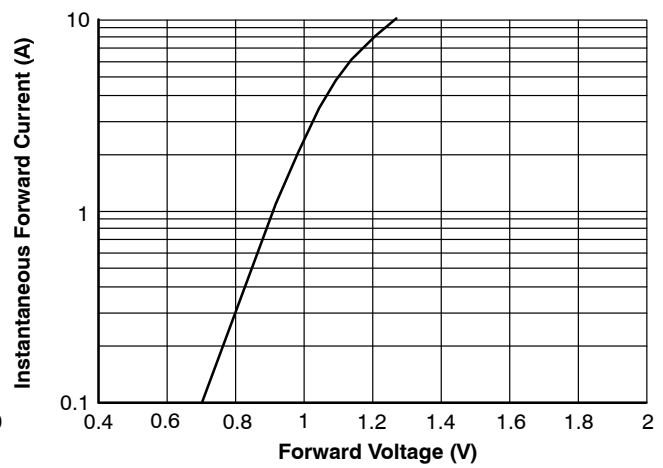


Figure 4. Typical Instantaneous Forward Characteristics

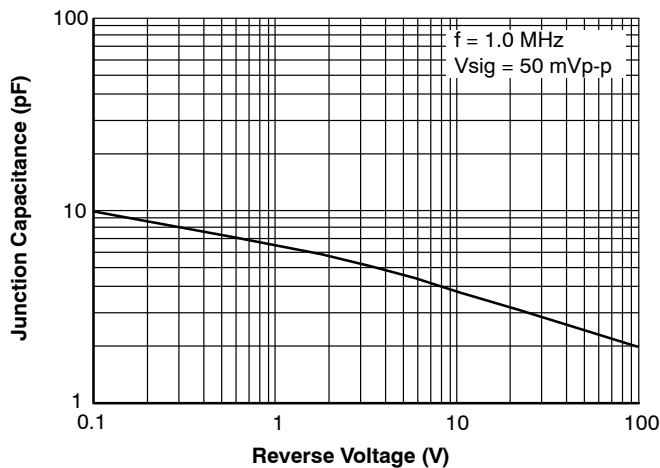


Figure 5. Typical Junction Capacitance

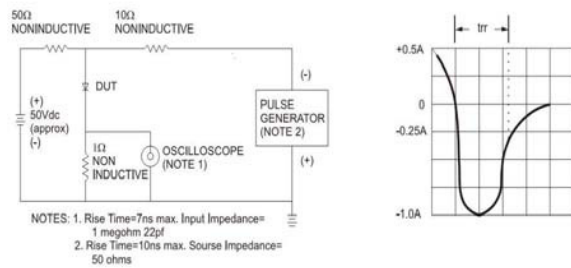
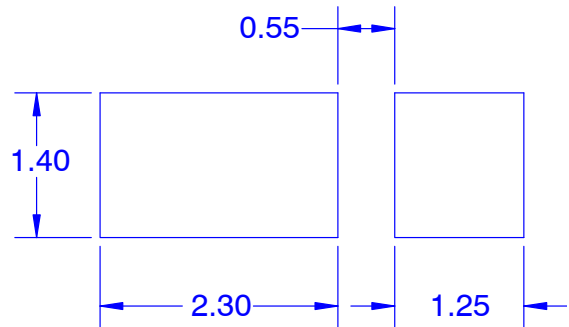
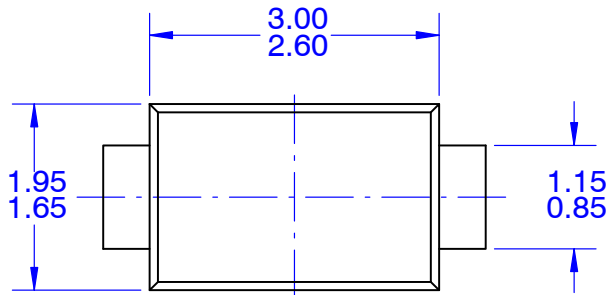


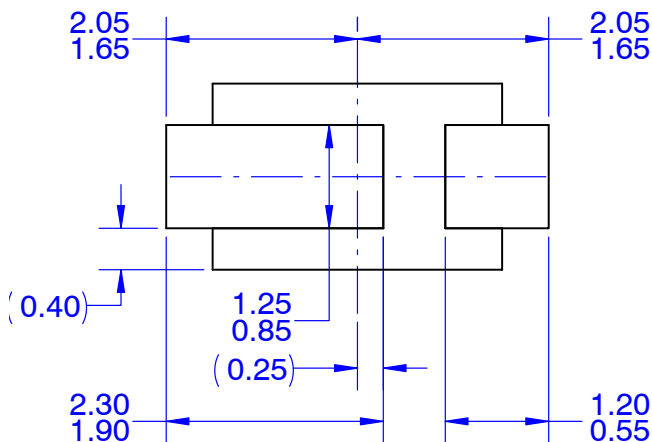
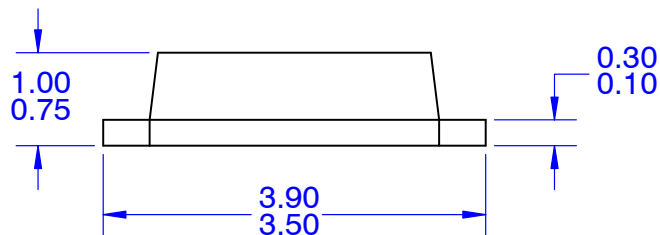
Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram

SOD-123EP
CASE 425AC
ISSUE O

DATE 31 AUG 2016



LAND PATTERN RECOMMENDATION
LONG PAD IS CATHODE



NOTES:

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